

ISL59112

40MHz Rail-to-Rail Video Buffer

NOT RECOMMENDED FOR NEW DESIGNS
RECOMMENDED REPLACEMENT PART
ISL59110

FN6142
Rev 4.00
March 15, 2007

The ISL59112 is a single rail-to-rail 6dB video buffer with a 3dB roll-off frequency of 40MHz and a slew rate of 60V/ μ s. Input signal DC restoration is accomplished with an internal sync tip clamp. Operating from single supplies ranging from +2.5V to +3.6V and sinking an ultra-low 2mA quiescent current, the ISL59112 is ideally suited for low power, battery-operated applications. It also features inputs capable of reaching down to 0.15V below the negative rail. Additionally, an enable high pin shuts the part down in under 20ns.

The ISL59112 is designed to meet the needs for very low power and bandwidth criteria inherent to battery operated communication, instrumentation and modern industrial applications, such as video on demand, cable set-top boxes, DVD players and HDTV. The ISL59112 is offered in a space-saving SC-70 package guaranteed to a 1mm maximum height constraint and specified for operation from -40°C to +85°C temperature range.

Ordering Information

PART NUMBER (Note)	PART MARKING	TAPE & REEL	PACKAGE (Pb-Free)	PKG. DWG. #
ISL59112IEZ-T7	CPA	7" (3k pcs)	6 Ld SC-70	P6.049A

NOTE: Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

Features

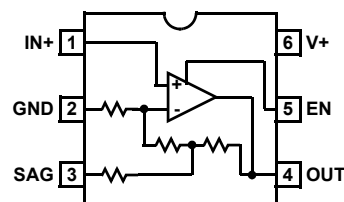
- 40MHz -3dB bandwidth
- 85V/ μ s slew rate
- Low supply current = 2mA
- Power-down current less than 1 μ A
- Supplies from 2.5V to 3.6V
- Rail-to-rail output
- Input to 0.15V below ground
- Internal sync tip clamp
- SAG correction reduces coupling capacitor size
- Pb-free plus anneal available (RoHS compliant)

Applications

- Video amplifiers
- Digital cameras
- Camera phones
- Portable/handheld products
- Communications devices
- Video on demand
- Cable set-top box
- Satellite set-top box
- DVD players
- HDTV
- Personal video recorders

Pinout

ISL59112
(6 LD SC-70)*
TOP VIEW



*1mm MAXIMUM HEIGHT GUARANTEED

Absolute Maximum Ratings ($T_A = +25^\circ\text{C}$)

Supply Voltage from V_{S+} to V_{S-} 3.6V
 Input Voltage $V_{S+} + 0.3\text{V}$ to $V_{S-} - 0.3\text{V}$
 Continuous Output Current 40mA
 ESD Rating
 Human Body Model (Per MIL-STD-883 Method 3015.7) ... 3000V
 Machine Model (Per EIAJ ED-4701 Method C-111) ... 300V

Thermal Information

Storage Temperature -65°C to $+125^\circ\text{C}$
 Ambient Operating Temperature -40°C to $+85^\circ\text{C}$
 Operating Junction Temperature $+125^\circ\text{C}$
 Power Dissipation See Curves
 Pb-free reflow profile see link below
<http://www.intersil.com/pbfree/Pb-FreeReflow.asp>

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

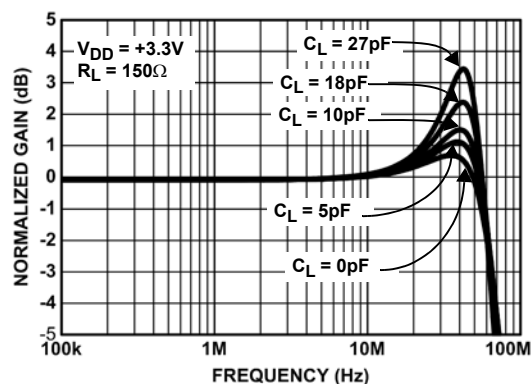
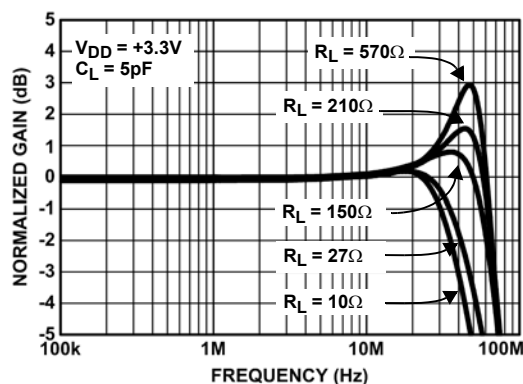
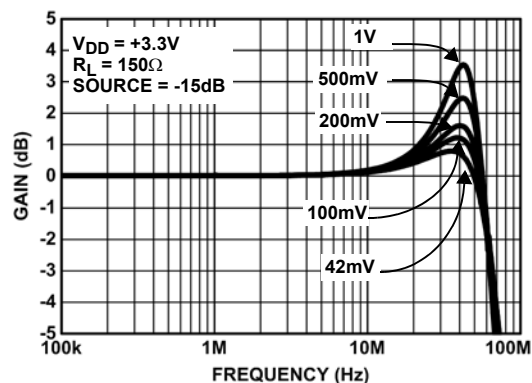
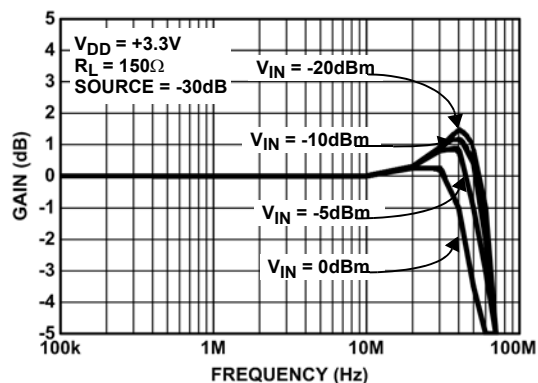
IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typ values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore: $T_J = T_C = T_A$

Electrical Specifications $V_{S+} = 3.3\text{V}$, $V_{S-} = \text{GND}$, $T_A = +25^\circ\text{C}$, $R_L = 150\Omega$ to GND, unless otherwise specified

DESCRIPTION	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
INPUT CHARACTERISTICS						
V _{CC}	Supply Voltage Range		2.5		3.6	V
I _{DD(ON)}	Quiescent Supply Current	V _{IN} = 500mV, EN = V _{DD} , no load		2	2.75	mA
I _{DD(OFF)}	Shutdown Supply Current	EN = 0V			3	μA
V _{OLS}	Output Level Shift Voltage	V _{IN} = 0V, no load	60	130	200	mV
V _{CLAMP}	Input Voltage Clamp	I _{IN} = -1mA	-40	-15	+10	mV
I _{CLAMP}	Clamp Current	V _{IN} = V _{CLAMP} - 100mV		-6	-3	mA
I _B	Input Bias Current	V _{IN} = 500mV	2.5	5	7.5	μA
R _{IN}	Input Resistance	0.5V < V _{IN} < 1.0V	0.5	3		MΩ
A _V	Voltage Gain	R _L = 150Ω	5.8	6.0	6.2	dB
A _{SAG}	SAG Correction DC Gain to V _{OUT}	SAG open		2.25		V/V
PSRR	DC Power Supply Rejection	V _{DD} = 2.7V to 3.3V	43	63		dB
V _{OH}	Output Voltage High Swing	V _{IN} = 2V, R _L = 150Ω to GND	2.85	3.2		V
I _{SC}	Output Short-Circuit Current	V _{IN} = 2V, to GND through 10Ω		-94	-65	mA
		V _{IN} = 100mV, out short to V _{DD} through 10Ω	65	115		mA
I _{ENABLE}	Enable Current	Enable pin = 0V to 3.6V	-3	0	+3	μA
V _{IL}	EN Logic Low Threshold	V _{DD} = 2.7V to 3.3V			0.8	V
V _{IH}	EN Logic High Threshold	V _{DD} = 2.7V to 3.3V	1.6			V
R _{OUT}	Shutdown Output Impedance	EN = 0V DC	3.6	4.5	5.9	kΩ
		EN = 0V, f = 4.5MHz		3.4		kΩ
AC PERFORMANCE						
BW	-3dB Bandwidth	R _L = 150Ω, C _L = 5pF		40		MHz
BW	±0.1dB Bandwidth	R _L = 150Ω, C _L = 5pF		27		MHz
dG	Differential Gain	NTSC and PAL DC coupled		0.02		%
		NTSC and PAL AC coupled		0.02		%
dP	Differential Phase	NTSC and PAL DC coupled		0.4		°
		NTSC and PAL AC coupled		0.04		°
D/DT	Group Delay Variation	f = 100kHz, 5MHz		5.4		ns
SNR	Signal To Noise Ratio	100% white signal		65		dB
t _{ON}	Enable Time	V _{IN} = 500mV, V _{OUT} to 1%		570		ns

Electrical Specifications $V_{S+} = 3.3V$, $V_{S-} = GND$, $T_A = +25^{\circ}C$, $R_L = 150\Omega$ to GND, unless otherwise specified (Continued)

DESCRIPTION	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
t_{OFF}	Disable Time	$V_{IN} = 500mV$, V_{OUT} to 1%		14		ns
SR(lh)	Positive Slew Rate	$V_{IN} = 1V_{STEP}$, 10% - 90%	30	85		V/ μs
SR(hl)	Negative Slew Rate	$V_{IN} = 1V_{STEP}$		-80	-30	V/ μs
t_F	Fall Time	$1.0V_{STEP}$		9		ns
t_R	Rise Time	$1.0V_{STEP}$, 20% - 80%		9		ns

Typical Performance CurvesFIGURE 1. FREQUENCY RESPONSE FOR VARIOUS C_{LOAD} FIGURE 2. FREQUENCY RESPONSE FOR VARIOUS R_{LOAD} FIGURE 3. FREQUENCY RESPONSE FOR VARIOUS V_{OS} FIGURE 4. FREQUENCY RESPONSE FOR VARIOUS V_{IN}

Typical Performance Curves (Continued)

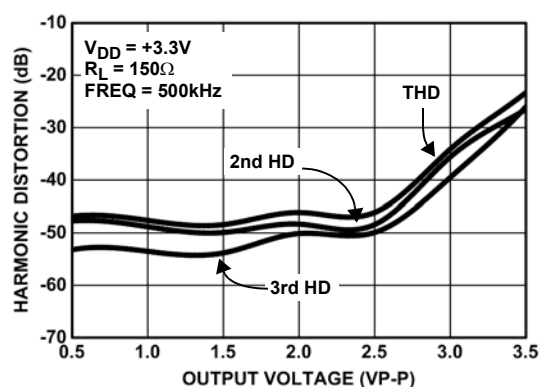


FIGURE 5. HARMONIC DISTORTION vs OUTPUT VOLTAGE

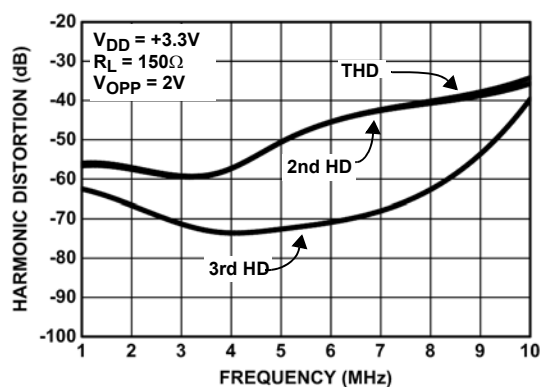


FIGURE 6. HARMONIC DISTORTION vs FREQUENCY

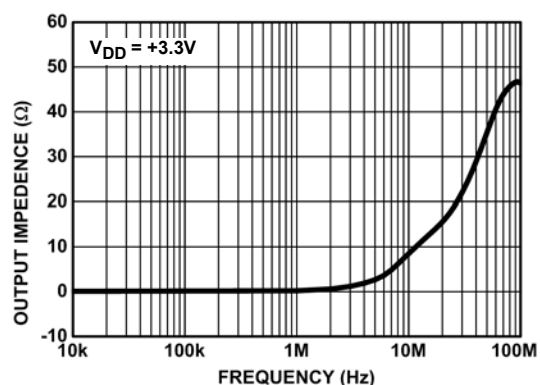


FIGURE 7. OUTPUT IMPEDANCE vs FREQUENCY

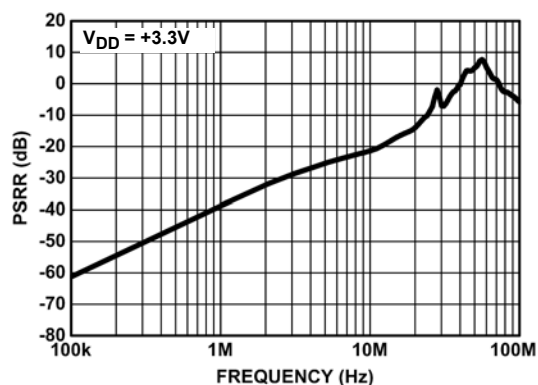


FIGURE 8. PSRR vs FREQUENCY

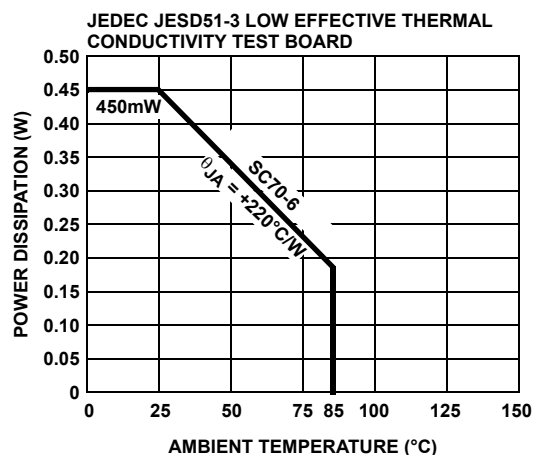


FIGURE 9. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

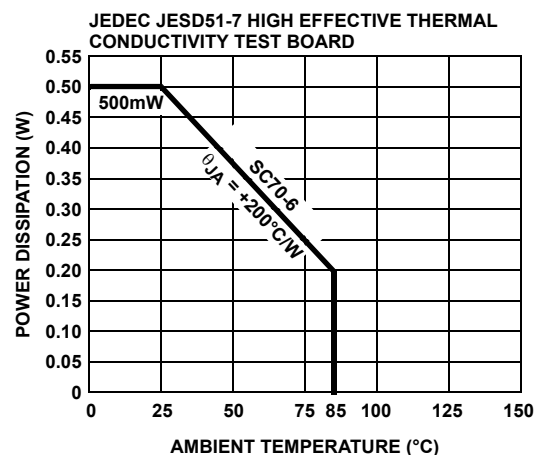


FIGURE 10. PACKAGE POWER DISSIPATION vs AMBIENT TEMPERATURE

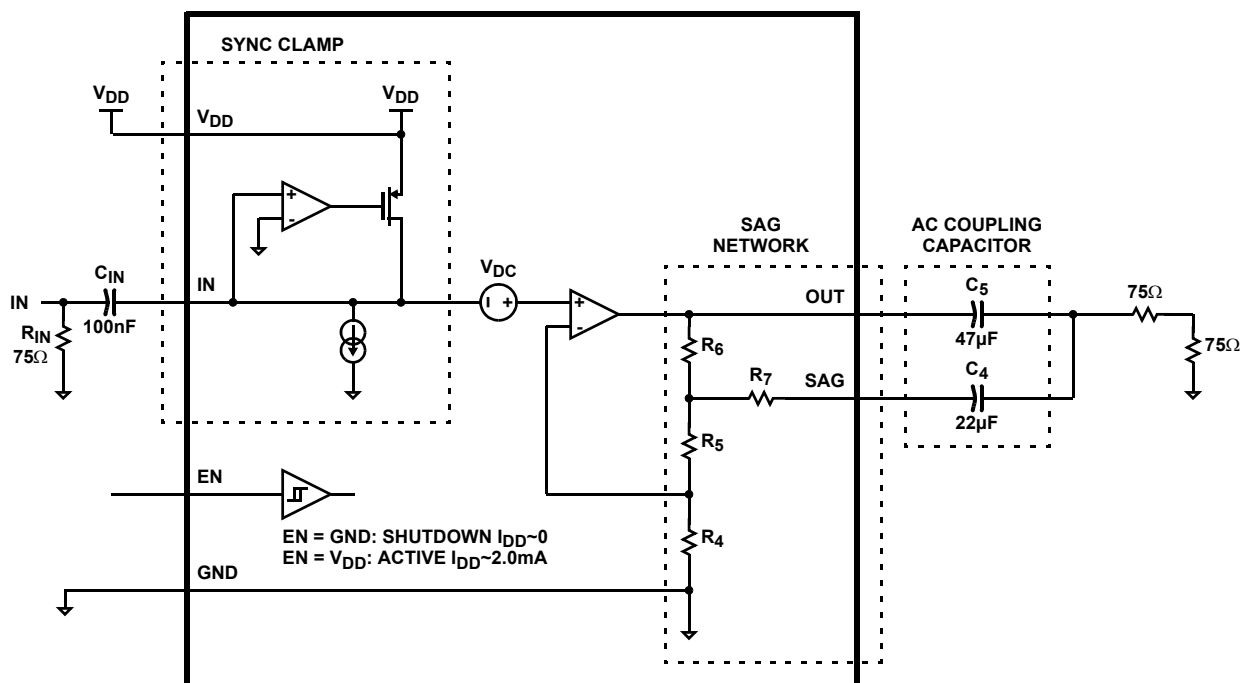


FIGURE 11. BLOCK DIAGRAM

Application Information

The ISL59112 is a single supply rail-to-rail output buffer achieving a -3dB bandwidth of around 40MHz and slew rate of about 85V/μs while demanding only 2mA of supply current. This part is ideally suited for applications with specific micropower consumption and high bandwidth demands. As described in both the performance characteristics section and the features section, the ISL59112 is designed to be very attractive for portable composite video applications.

The ISL59112 features a sync clamp and SAG network at the output facilitating reduction of typically large AC coupling capacitors. See Figure 11.

Internal Sync Clamp

The typical embedded video DAC operates from a ground referenced single supply. This becomes an issue because the lower level of the sync pulse output may be at a 0V reference level to some positive level. The problem is presenting a 0V input to most single supply driven amplifiers will saturate the output stage of the amplifier, resulting in a clipped sync tip and degrading the video image. A larger positive reference may offset the input above its positive range.

The ISL59112 features an internal sync clamp and an offset function to level shift the entire video signal to the best level before it reaches the input of the amplifier stage. These features are also helpful to avoid saturation of the output stage of the amplifier by setting the signal closer to the best voltage range.

The simplified block diagram of the ISL59112 in Figure 11 is divided into four sections. The first (Section A) is the Sync Clamp. The AC coupled video sync signal is pulled negative by a current source at the input of the comparator amplifier. When the sync tip goes below the comparator threshold, the output comparator is driven negative and the PMOS device turns on clamping sync tip to near ground level.

AC Output Coupling and the SAG Network

Composite video signals carry viable information at frequencies as low as 30Hz up to 5MHz. When a video system output is AC coupled it is critical that the filter represented by the output coupling capacitor and the surrounding resistance network provide a band pass function with a low pass band low enough to exclude very low frequencies down to DC, and with a high pass band pass sufficiently high to include frequencies at the higher end of the video spectrum.

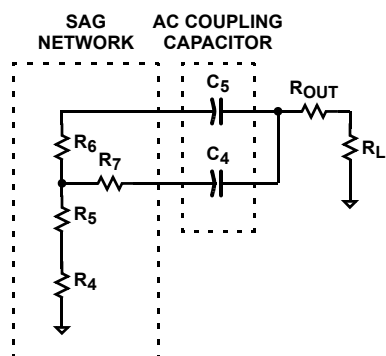


FIGURE 12. SAG NETWORK AND AC COUPLING CAPACITORS

Typically, this is accomplished with 220μF coupling capacitor, a large and somewhat costly solution providing a low frequency pole around 5Hz. If the size of this capacitor is even slightly reduced we have found that the accompanying phase shift in the 50Hz to 100Hz frequency range results in field tilt, which results in a degraded video image.

The internal SAG network of the ISL59112 replaces the 220μF AC coupling capacitor with a network of two smaller capacitors as shown, in Figure 12. Additionally, the network is designed to place a zero in the ~30Hz range, providing a small amount of peaking to compensate the phase response associated with field tilt.

DC Output Coupling

The ISL59112 internal sync clamp makes it possible to DC couple the output to a video load, eliminating the need for any AC coupling capacitor, thereby saving board space and additional expense for capacitors. Additionally, this solution completely eliminates the issue of field tilt in the lower frequency. The trade off is greater demand of supply current. Typical load current for AC coupled is around 3mA compared to typical 6mA used when DC coupling.

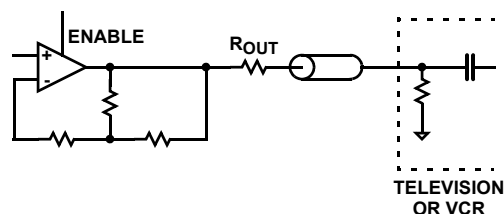


FIGURE 13. DC COUPLE

Output Drive Capability

The ISL59112 does not have internal short-circuit protection circuitry. If the output is shorted indefinitely, the power dissipation could easily overheat the die or the current could eventually compromise metal integrity. Maximum reliability is maintained if the output current never exceeds ±40mA. This limit is set by the design of the internal metal interconnect. Note that in transient applications, the part is robust.

Short-circuit protection can be provided externally with a back match resistor in series with the output placed close as possible to the output pin. In video applications this would be a 75Ω resistor and will provide adequate short-circuit protection to the device. Care should still be taken not to stress the device with a short at the output.

Power Dissipation

With the high output drive capability of the ISL59112, it is possible to exceed the +125°C absolute maximum junction temperature under certain load current conditions. Therefore, it is important to calculate the maximum junction temperature for an application to determine if load conditions or package types need to be modified to assure operation of the amplifier in a safe operating area.

The maximum power dissipation allowed in a package is determined according to Equation 1:

$$P_{D_{MAX}} = \frac{T_{J_{MAX}} - T_{A_{MAX}}}{\Theta_{JA}} \quad (\text{EQ. 1})$$

Where:

$T_{J_{MAX}}$ = Maximum junction temperature

$T_{A_{MAX}}$ = Maximum ambient temperature

Θ_{JA} = Thermal resistance of the package

The maximum power dissipation actually produced by an IC is the total quiescent supply current times the total power supply voltage, plus the power in the IC due to the load, or

for sourcing:

$$P_{D_{MAX}} = V_S \times I_{S_{MAX}} + (V_S - V_{OUTi}) \times \frac{V_{OUTi}}{R_{Li}} \quad (\text{EQ. 2})$$

for sinking:

$$P_{D_{MAX}} = V_S \times I_{S_{MAX}} + (V_{OUTi} - V_S) \times I_{LOADi} \quad (\text{EQ. 3})$$

Where:

V_S = Supply voltage

$I_{S_{MAX}}$ = Maximum quiescent supply current

V_{OUT} = Maximum output voltage of the application

R_{LOAD} = Load resistance tied to ground

I_{LOAD} = Load current

By setting the two $P_{D_{MAX}}$ equations equal to each other, we can solve the output current and R_{LOAD} to avoid the device overheat.

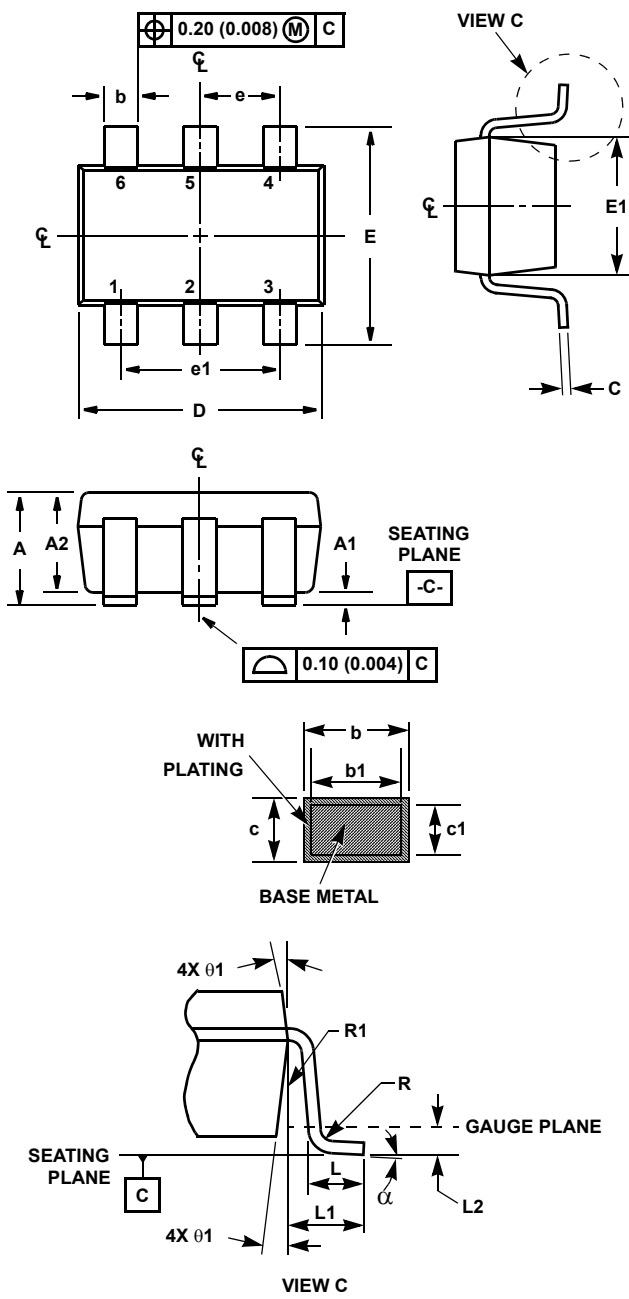
Power Supply Bypassing Printed Circuit Board Layout

As with any modern operational amplifier, a good printed circuit board layout is necessary for optimum performance. Lead lengths should be as short as possible. The power supply pin must be well bypassed to reduce the risk of oscillation. For normal single supply operation, where the V_{S-} pin is connected to the ground plane, a single 4.7 μ F tantalum capacitor in parallel with a 0.1 μ F ceramic capacitor from V_{S+} to GND will suffice. This same capacitor combination should be placed at each supply pin to ground if split supplies are to be used. In this case, the V_{S-} pin becomes the negative supply rail.

Printed Circuit Board Layout

For good AC performance, parasitic capacitance should be kept to minimum. Use of wire wound resistors should be avoided because of their additional series inductance. Use of sockets should also be avoided if possible. Sockets add parasitic inductance and capacitance that can result in compromised performance. Minimizing parasitic capacitance at the amplifier's inverting input pin is very important. The feedback resistor should be placed very close to the inverting input pin. Strip line design techniques are recommended for the signal traces.

Small Outline Transistor Plastic Packages (SC70-6)



P6.049A
6 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.031	0.039	0.80	1.00	-
A1	0.001	0.004	0.025	0.10	-
A2	0.034	0.036	0.85	0.90	-
b	0.006	0.012	0.15	0.30	-
b1	0.006	0.010	0.15	0.25	-
c	0.004	0.008	0.10	0.20	6
c1	0.004	0.006	0.10	0.15	6
D	0.073	0.085	1.85	2.15	3
E	0.084 BSC		2.1 BSC		-
E1	0.045	0.053	1.15	1.35	3
e	0.0256 Ref		0.65 Ref		-
e1	0.0512 Ref		1.30 Ref		-
L	0.010	0.018	0.26	0.46	4
L1	0.016 Ref.		0.400 Ref.		-
L2	0.006 BSC		0.15 BSC		-
N	6		6		5
R	0.004	-	0.10	-	-
α	0°	8°	0°	8°	-

Rev. 0 7/05

- NOTES:
- 1. Dimensioning and tolerance per ASME Y14.5M-1994.
 - 2. Package conforms to EIAJ SC70 and JEDEC MO203AB.
 - 3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
 - 4. Footlength L measured at reference to gauge plane.
 - 5. "N" is the number of terminal positions.
 - 6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
 - 7. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only

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